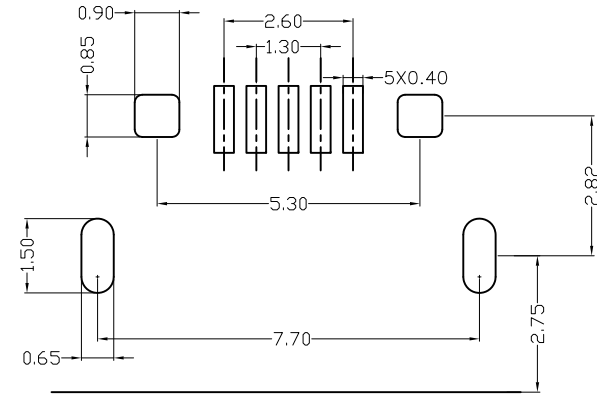
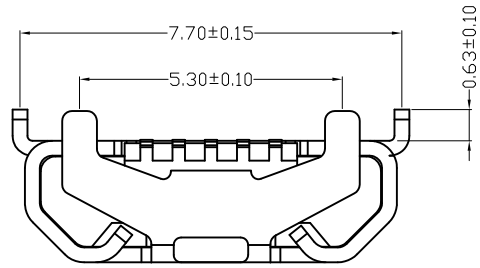
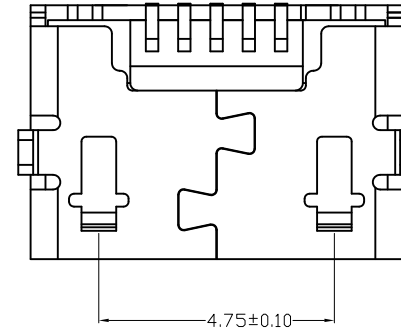
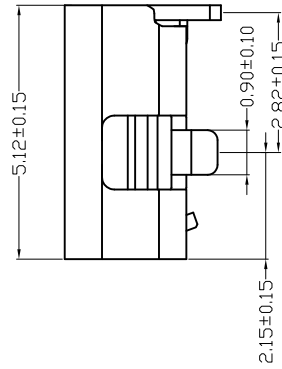
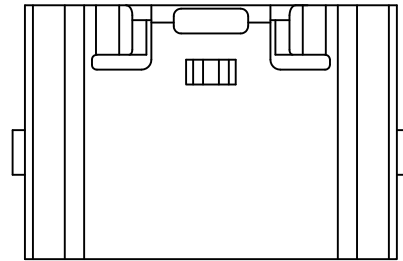


REV.	NOTES	DATE
A	RELEASED	2017/10/11

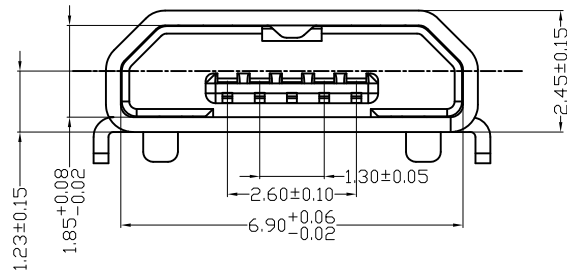


PCB LAYOUT



Note:

1. Material:
 - 1.1 Housing: LCP UL94v-0 BLACK
 - 1.2 Contact: copper alloy, t=0.15mm
 - 1.3 Shell: SUS
2. Specification:
 - 2.1 Current rating: 1 A Max.
 - 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - 2.3 Contact resistance: 30 mΩ Max.
 - 2.4 Insulation resistance: 100 MΩ Min.
 - 2.5 Total mating force: 3.57 Kg Max.
 - 2.6 Total unmating force: 1.0 Kg Min. 0.81~2.05 Kg Min. after 10000 insertion/extraction cycles
 - 2.7 Temperature range: -30°C~80°C



DIMENSIONS TOLERANCE METRIC

- X : ±0.5
 X.X : ±0.30
 X.XX : ±0.20
 ANGLES
 X : ±1°
 X.X : ±0.5°

單位(UNITS)	mm
數量(QT'Y)	N/A
材料(MT'L)	SEE NOTE
處理(FINISH)	SEE NOTE

東莞翊豐精密五金有限公司

圖名(NAME)

MICRO 5P/F B 反向牛角內DIP 0.6(7.7*5.3) 无卷边

繪圖(DRAW)		料號(PART NUMBER)	AAUS+MC05P-7753						
設計(DE'N)		圖號(DRAW NUMBER)							
審校(CH'K)		圖檔(FILE NAME .DWG)							
核准(APP'D)		比例(SCALE)	1/1	圖紙(SIZE)	A4	頁次(SHEET)	1	版次(REV.)	A